## Organic Process Research & Development

Organic Process Research & Development 2002, 6, 741

## Editorial

## **Suggestions for Special Issues**

I was recently sent, by a Japanese member of our Editorial Advisory Board, the abstracts of a symposium on process chemistry held in Japan earlier this year. Of course, most of the papers were in Japanese, so I could not glean much except by looking at the names of the authors, the university or company presenting, and the schemes. The large number of attendees was a sign that process chemistry in Japan is of great interest and that there is a willingness, which was perhaps absent in the past, to share knowledge of this vital topic. The symposium was organized by the Japanese Society of Process Chemistry, which was launched in 2002. They no doubt, have plans for further events in the future. I hope this will lead to many more papers from Japan in *Organic Process Research & Development*.

This last issue of 2002 contains contributions on the special theme, Safety of Chemical Processes. These special issues have been well received by readers, and we will have two special issues each year. Suggestions for topics for future special issues are invited from readers of *Organic Process Research & Development*. We discuss ideas at the regular Editorial Advisory Board meetings. Topics we have covered in the past include oligonucleotides, polymorphism and crystallization, laboratory automation, biocatalysis, and continuous processes. Please let me know if you have any brilliant ideas for the last issue of 2003, which we need to start planning soon, or for 2004. I know it seems a long way ahead, but potential authors need a long lead time to cope with the approvals procedures in their own companies (often slow!) as well as our refereeing process (usually fast!). As mentioned in the editorial in the last issue, the next special issue in 2003 is on Homogeneous Transition Metal-Catalysed Reactions (to submit a manuscript, contact the editors or Chris Goralski (e-mail: ctgoralski@dow.com).

Trevor Laird

Editor

OP025600S